



R U N A U

Jiangsu Runau Electronics Manufacturing Co.,Ltd

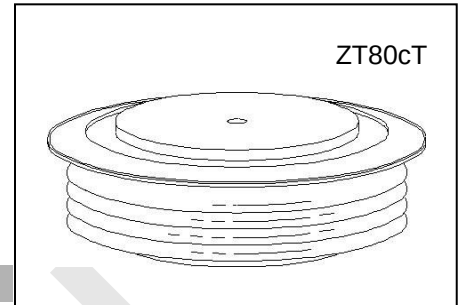
YA801-Standard Diode

2700~3200 V_{RRM}

STANDARD DIODE WITH HIGH JUNCTION TEMPERATURE

Features:

- . All diffused structure
- . Blocking capability up to 3200 volts
- . Soft reverse recovery
- . Rugged ceramic hermetic package
- . Pressure assembled device



ELECTRICAL CHARACTERISTICS AND RATINGS

Reverse Blocking

Device Type	V _{RRM} (1)	V _{RSM} (1)
YA801LS	2700	2900
YA801LN	2800	3000
YA801LT	2900	3100
YA801CP	3000	3200
YA801CA	3100	3300
YA801CB	3200	3400

V_{RRM} = Repetitive peak reverse voltage

V_{RSM} = Non repetitive peak reverse voltage (2)

Repetitive peak reverse leakage current	I _{RRM}	10 mA 50 mA (3)
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Notes:

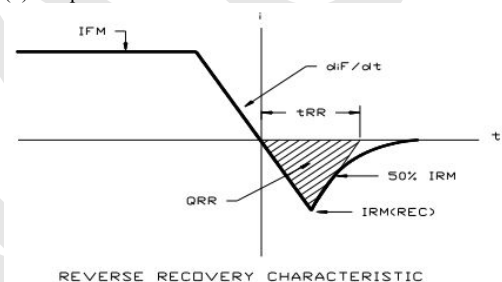
All ratings are specified for T_j=25 °C, unless otherwise stated

(1) All voltage ratings are specified for an applied 50Hz/60Hz sinusoidal waveform over the temperature range -40 to +175°C.

(2) 10 msec. max. pulse width

(3) Maximum value for T_j = 175 °C.

(4) See parameter definition below :



Conducting - on state

Parameter	Symbol	Min.	Max.	Typ.	Units	Conditions
Average forward current	I _{F(AV)}		3900		A	Sinewave 180°, T _c =100°C
RMS forward current	I _{FRMS}		6123		A	Nominal value
Peak one cycle surge (non repetitive) current	I _{FSM}		60000 57000		A	8.3 msec (60Hz), sinusoidal wave-shape, 180° conduction, T _j = 160 °C 10 msec (50Hz), sinusoidal wave-shape, 180° conduction, T _j = 160 °C
I square t	I ² t		1.6x10 ⁷		A ² s	8.3 msec and 10.0 msec
Peak forward voltage	V _{FM}		1.05		V	I _{FM} = 2000A; Duty cycle ≤0.01%; T _j =150°C
Reverse Recovery Current (4)	I _{RM(REC)}		310		A	dI _F /dt = 10 A/μs; T _j =175°C
Reverse Recovery Charge (4)	Q _{rr}		*		μC	
Reverse Recovery Time (4)	t _{rr}		*		μs	

* For guaranteed maximum values, contact factory

Parameter	Symbol	Min.	Max.	Typ.	Units	Conditions
Operating temperature	T_j	-40	+175		°C	
Storage temperature	T_{stg}	-40	+175		°C	
Thermal resistance - junction to case	$R_{\Theta(j-c)}$		0.012 0.024		°C/W	Double sided cooled Single sided cooled
Thermal resistance - case to heatsink	$R_{\Theta(c-s)}$		0.001 0.002		°C/W	Double sided cooled * Single sided cooled*
Mounting force	P			35	kN	
Weight	W			1.1	kg.	

* Mounting surfaces smooth, flat and greaseless

CASE OUTLINE AND DIMENSIONS

